APPLICA	BLE STAN	IDARD										
Operating tem range		nperature	-55 °C to 85	5 °C	Stora range	•	e temperature		-10 °C to 50 °C (packed condition			
RATING	Voltage		30 V AC / DC hum		humi	erating or storage midity range		Relative humidity 90%MAX(not			t dewed)	
	Current		0.20 A Appl			licable cable t=0.12±0.02mm, gold			d platin	plating		
			SPEC	CIFIC	ATIOI	NS						
I7	ГЕМ		TEST METHOD				RE	QUIRE	MENTS	QT	АТ	
CONSTR	RUCTION											
General examination		Visually a	Visually and by measuring instrument.				According to drawing.				×	
Marking		Confirmed visually.				(note 1,2)				×	×	
ELECTR	ICAL CHA	RACTE	RISTICS									
Voltage proof		90 V AC for 1 min.				No flashover or breakdown.				×	×	
Insulation re	esistance	100 V DC.			50 MΩ MIN.				×	×		
Contact resi	stance	AC 20 mV MAX (1KHz), 1 mA.			200 mg	Ω MAX.			×	×		
		, "				Including FPC bulk resistance (L=8mm)						
MECHAN	NICAL CHA	ARACTE	RISTICS			1	g 5 5 an		(= c)		1	
Vibration		Frequenc	y 10 to 55 Hz, half amplitud	de 0.75 m	nm,	① No	electrical di	iscontir	nuity of 1 μs.	×	Τ_	
		for 10 cycles in 3 axial directions.				2 Cor	ntact resista	ance: 2	00 mΩ MAX.			
Shock		981 m/s <sup>2</sup> , duration of pulse 6 ms at 3 times in 3 both axial directions.				③ No damage, crack and looseness of parts.				s. ×	-	
Mechanical	operation	10 times insertions and extractions.				<ol> <li>Contact resistance: 200 mΩ MAX.</li> <li>No damage, crack and looseness of parts.</li> </ol>				×	-	
FPC retention	on force	Measured	Measured by applicable FPC.			Direction of insertion: (0.15 × n)+0.7N MIN(note3)					+_	
		(thickness of FPC shall be t=0.12mm at initial condition)				(n: Number of contacts)						
ENI/IRO	NIMENITAL	l .	ACTERISTICS			1						
Corrosion sa			at 35±2°C, 5% salt water	spray for	96 h.	Contac	t resistance	e: 200 i	mQ MAX.	×	1_	
			a. 55=2 5, 575 5a.t mate.	ορ.ω, .σ.								
Rapid change of temperature		Temperature -55 $\rightarrow$ +15 to +35 $\rightarrow$ +85 $\rightarrow$ +15 to +35 $^{\circ}$ C Time 30 $\rightarrow$ 2 to 3 $\rightarrow$ 30 $\rightarrow$ 2 to 3 min			<ol> <li>Contact resistance: 200 mΩ MAX.</li> <li>Insulation resistance: 50 MΩ MIN.</li> <li>No damage, crack and looseness of parts.</li> </ol>				×	-		
		Under 5 cycles.							3.			
Damp heat (steady state	e)	Exposed at 40±2°C, Relative humidity 90 to 95 %, 96 h.								×	-	
Damp heat,		Exposed at -10 to +65°C,			① Contact resistance: 200 mΩ MAX. ② Insulation resistance: 1 MΩ MIN.				×	†-		
		Relative humidity 90 to 96 %,										
		10 cycles	s, total 240 h.			-	at high hum		FO MO MINI			
						③ Insulation resistance: 50 MΩ MIN. (at dry)						
						No damage, crack and looseness of parts.				S.		
Dry heat		Exposed	osed at 85±2°C, 96 h.			① Contact resistance: 200 mΩ MAX.				×	_	
Cold			posed at -55±3°C, 96 h.			② No damage, crack and looseness of parts.				S. ×		
Sulphur diox			osed at 40±2°C,			Contact resistance: 200 mΩ MAX.				×	-	
[JIS	0 0 00000-2-42		humidity 80±5% m for 96 h.									
Hydrogen sı	ulphide		at 40±2°C,							×	+-	
		Relative	humidity 80±5%,									
COLIN	10 to 15 ppm for 96 h.  COUNT DESCRIPTION OF REVISION					SNED		CHECKED		D/	DATE	
<b>A</b>					320.0							
REMARK	1						APPROVE	D	NF. MIYAZAKI	17.	02. 1	
							CHECKE	D	YH. MICHIDA	_	02. 1	
						DESIGNED		D HY. YAMAZAKI		17.	02. 10	
Unless oth	herwise spe	cified, re	fer to IEC 60512.				DRAWN	ı	RK. OGASAWARA	17.	02. 1	
			surance Test X:Applicable	Test	DF	RAWING NO. ELC-375451-		99-00				
			PART	NO.	FH	FH64MA-**S-0. 25SHW(						
HS.			ECTRIC CO., LTD.		CODE NO.			CL580 2			1/2	
ODM HDOO11					JUDE			<u> </u>			.,.	

SPECIFICATIONS								
ITEM	TEST METHOD	REQUIREMENTS	QT	AT				
Solderability	Soldered at solder temperature, 245±3°C for immersion duration, 3±0.3 sec.	A new uniform coating of solder shall cover a minimum of 95% of the surface being immersed.	×	_				
Resistance to soldering heat	1) Reflow soldering: Peak TMP. 250°C MAX. Reflow TMP. over 230°C within 60 sec. Number of allowed reflow cycles 2 times. 2) Soldering irons: TMP. 350±10°C for 5±1 sec.	No deformation of case of excessive looseness of the terminals. ( <i>note 4</i> )	×	_				

## (note1)

This is a top contact point connector with back flip lock system.

## (note2)

Do not close the actuator before inserting FPC even after the connector is mounted onto a PCB.

Closing the actuator without FPC could make the contact gap smaller, which increases the FPC insertion force.

## (note3)

Stabilize the FPC to PCB or something fixed, if pull-up or pull-down force is exepected to be applied to the FPC.

There is a case which the FPC retention force doesn't fullfill the specification depending on the FPC specification.

## (note4)

Blisters which may be generated on the housing do not affect product performance.

Note C	Note QT:Qualification Test AT:Assurance Test X:Applicable Test			IG NO.	ELC-375451-99-00		
HR	SPECIFICATION SHEET		PART NO.	FH64MA-**S-0. 25SHW(99)			
* * *	J	HIROSE ELECTRIC CO., LTD.	CODE NO		CL580	Δ	2/2